

Product Change Notification / ASER-05VRGQ325

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22-Feb-2021

Product Category:

Ultrasound T/R Switch ICs

PCN Type:

Manufacturing Change

Notification Subject:

CCB 4173 Final Notice: Qualification of NSEB as a new assembly site for selected MD010xxx device families available in 18L VDFN (5x5x1.0mm) package.

Affected CPNs:

ASER-05VRGQ325_Affected_CPN_02222021.pdf ASER-05VRGQ325_Affected_CPN_02222021.csv

Notification Text:

PCN Status: Final notification.

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:Qualification of NSEB as a new assembly site for selected MD010xxx device families available in 18L VDFN (5x5x1.0mm) package.

Pre Change: Assembled at CARC using EME-G770HCD molding compound.

Post Change:Assembled at NSEB using G700LTD molding compound.

Pre and Post Change Summary:

	Pre Change	Post Change				
Assembly Site	Carsem (Suzhou)	UTAC Thai Limited				
	(CARC)	NSEB (UTL)				
Wire material	Au	Au				
Die attach material	8006NS	8006NS				
Molding compound material	EME-G770HCD	G700LTD				
Lead frame material	C194	C194				

Impacts to Data Sheet:None

Change Impact:

None

Reason for Change:

To improve manufacturability by qualifying NSEB as a new assembly site

Change Implementation Status:

In Progress

Estimated First Ship Date:March 10, 2021 (date code: 2111)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	March 2020			>	February 2021			March 2021							
Workweek	10	11	12	13	14		06	07	80	09	10	11	12	13	14
Initial PCN Issue Date				Х											
Qual Report Availability										Χ					
Final PCN Issue Date										Χ					
Estimated Implementation Date												Χ			

Method to Identify Change:Traceability code

Qualification Report:

Please open the attachments included with this PCN labeled as PCN_#_Qual_Report

Revision History:

March 18, 2020: Issued initial notification.

February 22, 2021: Issued final notification. Attached the Qualification Report. Updated the typo in the revision history initial PCN issuance date from March 18, 2019 to March 18, 2020. Provided estimated first ship date to be onMarch 10, 2021.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_ASER-05VRGQ325_Qual Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our <u>PCN</u> home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the <u>PCN FAQ</u> section.

If you wish to <u>change your PCN profile, including opt out,</u> please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.

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Affected Catalog Part Numbers (CPN)
MD0101K6-G
MD0105K6-G

Date: Sunday, February 21, 2021

MD0105K6-G-M932